

# RAA23012x RAA23013x

16V Input, 3A, Step-Down DC/DC Converter  
+ Battery Backup

R18DS0015EJ0100  
REV.1.00  
Apr.15.2015

## Description

The RAA23012x and RAA23013x are 1CH step-down DC/DC converter, 4.5V to 16V input voltage range and 3A output current. Auto PFM mode makes devices low power operation at light load, so it makes a system lower power.

The RAA23012x is suitable for battery backup system using lithium primary cell with built-in battery backup circuit.

## Features

- DC/DC
  - Synchronous rectification type step-down DC/DC
  - Auto PFM mode
  - Battery backup circuit (RAA23012x)
  - Input voltage range 4.5V to 16V
  - Output voltage range 0.8V to 6V
  - Maximum output current 3A
  - Shutdown current 1uA (typ.)
  - Switching frequency 1.1MHz (fixed)
  - Soft start 2ms (fixed)
  - Integrated power MOSFETs
  - Discharge circuit
  - Internal phase compensator
- Protection circuit
  - Short circuit protection (latch type)
  - Thermal shutdown circuit 165°C (typ.)
  - Under voltage lockout circuit (recovery type)
- Package
  - 16-pin HTSSOP (RAA23012x)
  - 8-pin HLSOP (RAA23013x)

## Application

Communication (Router, Home Gate Way, Radio, etc.)  
Industrial (Surveillance camera, Various controller, etc.)  
Building (Security device, Emergency device, Various controller, etc.)  
OA (Printer, Plane paper copier, etc.)  
Smart meter  
Smart home appliances  
And, usable various application

Note: The information contained in this document is being issued in advance of the production cycle for the product. The parameters for the product may change before final production, or Renesas Electronics Corporation, at its own discretion, may withdraw the product prior to its production.

A quality grade of RAA23012x series is "Standard". Recommended applications are indicated below.  
Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment, and industrial robots, etc.

## Product Lineup Table

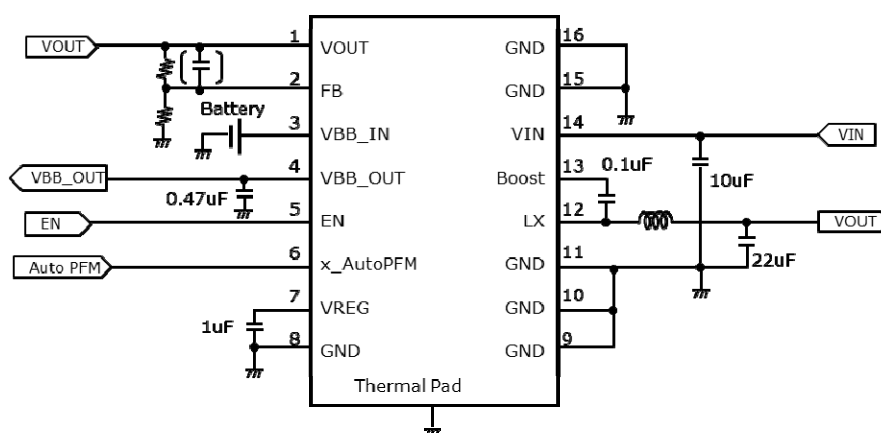
| Part number | Output | Type                         | VIN range  | VOUT                       | IOUT (max.) | Package      | Switching frequency |
|-------------|--------|------------------------------|------------|----------------------------|-------------|--------------|---------------------|
| RAA230121   | 1      | Step-down + BB <sup>*1</sup> | 4.5 to 16V | 3.3V(fixed)                | 3A          | 16pin HTSSOP | 1.1MHz              |
| RAA230122   | 1      | Step-down + BB <sup>*1</sup> | 4.5 to 16V | 5.0V(fixed)                | 3A          | 16pin HTSSOP | 1.1MHz              |
| RAA230123   | 1      | Step-down + BB <sup>*1</sup> | 4.5 to 16V | 0.8V to 6.0V <sup>*2</sup> | 3A          | 16pin HTSSOP | 1.1MHz              |
| RAA230131   | 1      | Step-down                    | 4.5 to 16V | 3.3V(fixed)                | 3A          | 8pin HLSOP   | 1.1MHz              |
| RAA230132   | 1      | Step-down                    | 4.5 to 16V | 5.0V(fixed)                | 3A          | 8pin HLSOP   | 1.1MHz              |
| RAA230133   | 1      | Step-down                    | 4.5 to 16V | 0.8V to 6.0V <sup>*2</sup> | 3A          | 8pin HLSOP   | 1.1MHz              |

Note \*1 BB : Battery Backup

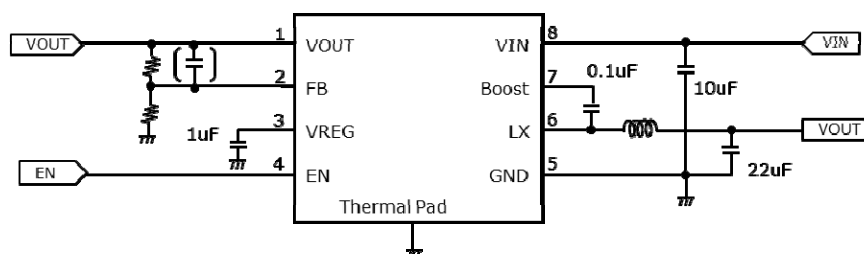
\*2 Adjustable by external resistors

## Circuit example

### RAA23012x (1CHDCDC + Battery Backup, VOUT set by external resistors)

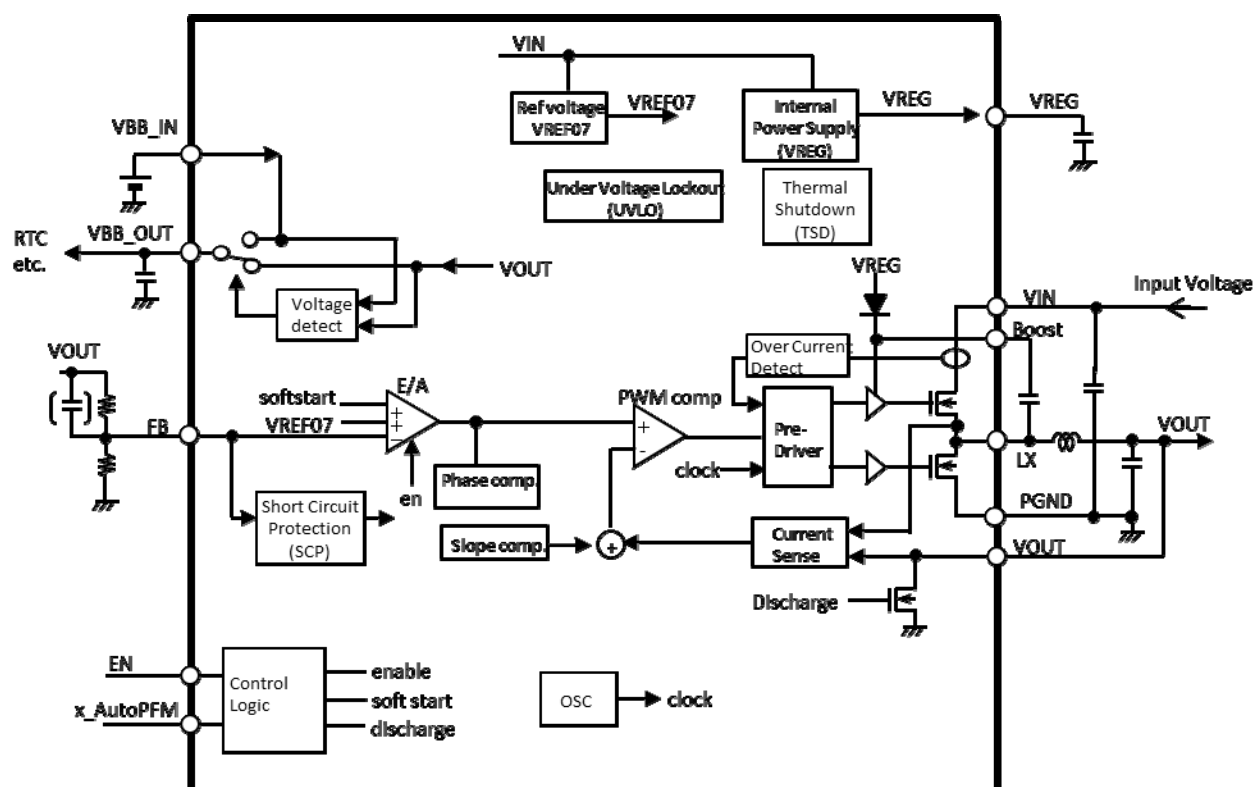


### RAA23013x (1CHDCDC, VOUT set by external resistors)

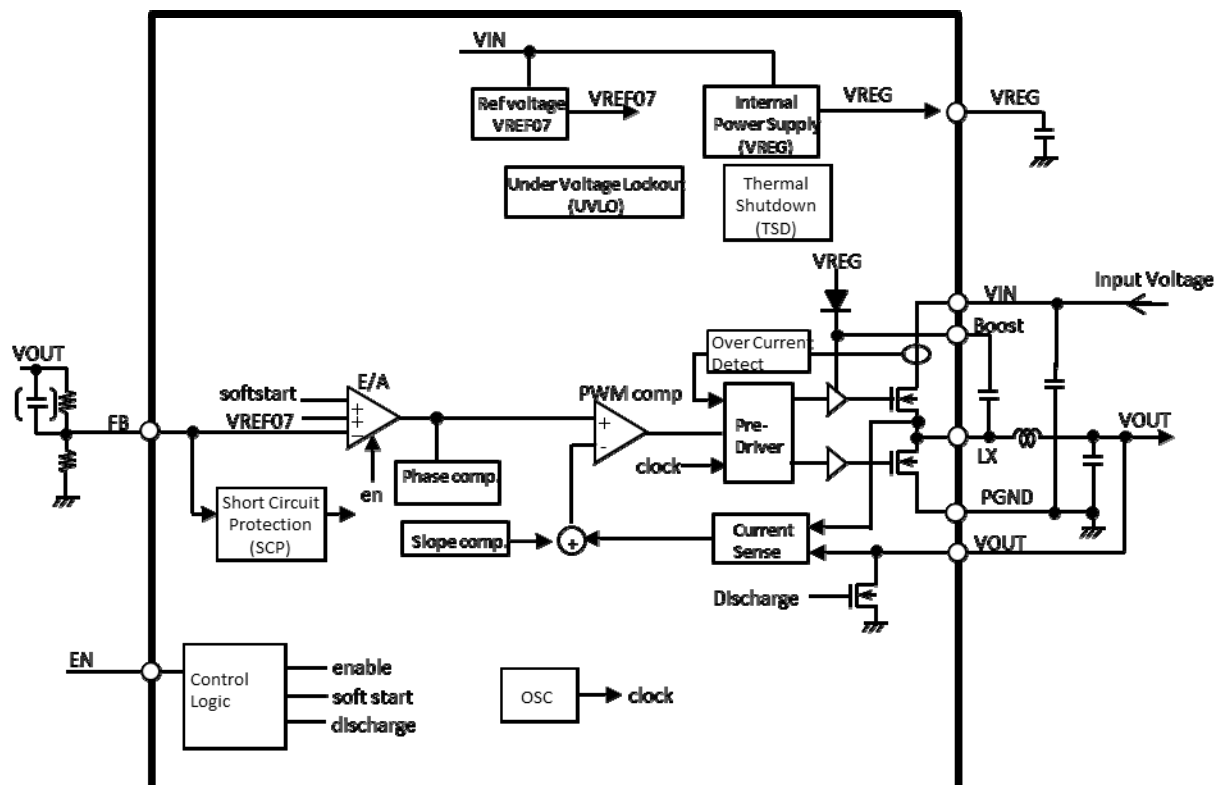


## Block Diagram

RAA23012x (1CHDCDC + Battery backup, VOUT set by external resistors)



# RAA23013x (1CHDCDC, VOUT set by external resistors)



## Pin Function

### RAA23012x (1CHDCDC + Battery backup)

| Pin No. | Symbol    | I/O | Function                                                                                                                                                             |
|---------|-----------|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1       | VOUT      | I   | VOUT feedback                                                                                                                                                        |
| 2       | FB        | I   | Feedback resistor connection                                                                                                                                         |
| 3       | VBB_IN    | I   | Battery connection                                                                                                                                                   |
| 4       | VBB_OUT   | O   | Backup voltage output                                                                                                                                                |
| 5       | EN        | I   | Device enable<br>EN="L" : Disable (shutdown)<br>EN="H" : Enable (operation)                                                                                          |
| 6       | x_AutoPFM | I   | Auto PFM mode ON/OFF<br>x_AutoPFM="L" : Auto PFM mode (change automatically)<br>PFM mode at light load<br>PWM mode at heavy load<br>x_AutoPFM="H" : PWM mode (fixed) |
| 7       | VREG      | O   | Internal power supply output<br>(Connect 1uF capacitor between VREG and GND)                                                                                         |
| 8       | GND       | I/O | Ground                                                                                                                                                               |
| 9       | GND       | I/O | Ground                                                                                                                                                               |
| 10      | GND       | I/O | Ground                                                                                                                                                               |
| 11      | GND       | I/O | Ground                                                                                                                                                               |
| 12      | LX        | O   | Inductor connection                                                                                                                                                  |
| 13      | Boost     | I   | Boot strap input (Connect 0.1uF capacitor between LX and Boost)                                                                                                      |
| 14      | VIN       | I   | Power supply                                                                                                                                                         |
| 15      | GND       | I/O | Ground                                                                                                                                                               |
| 16      | GND       | I/O | Ground                                                                                                                                                               |

### RAA23013x (1CHDCDC)

| Pin No. | Symbol | I/O | Function                                                                     |
|---------|--------|-----|------------------------------------------------------------------------------|
| 1       | VOUT   | I   | VOUT feedback                                                                |
| 2       | FB     | I   | Feedback resistor connection                                                 |
| 3       | VREG   | O   | Internal power supply output<br>(Connect 1uF capacitor between VREG and GND) |
| 4       | EN     | I   | Device enable<br>EN="L" : Disable (shutdown)<br>EN="H" : Enable (operation)  |
| 5       | GND    | I/O | Ground                                                                       |
| 6       | LX     | O   | Inductor connection                                                          |
| 7       | Boost  | I   | Boot strap input (Connect 0.1uF capacitor between LX and Boost)              |
| 8       | VIN    | I   | Power supply                                                                 |

## Absolute Maximum Ratings

(Unless otherwise specified,  $T_A = 25^{\circ}\text{C}$ )

| Parameter                             |              | Symbol           | Ratings            | Unit               | Condition                                   |
|---------------------------------------|--------------|------------------|--------------------|--------------------|---------------------------------------------|
| VIN applied voltage                   |              | VIN              | -0.3 to +17.6      | V                  | VIN                                         |
| EN applied voltage                    |              | EN               | -0.3 to +17.6      | V                  | EN                                          |
| x_AutoPFM applied voltage (RAA23012x) |              | x_AutoPFM        | -0.3 to +17.6      | V                  | x_AutoPFM                                   |
| FB applied voltage                    |              | FB               | -0.3 to +6.5       | V                  | FB                                          |
| VOUT applied voltage                  |              | VOUT             | -0.3 to +6.5       | V                  | VOUT                                        |
| VBB_IN applied voltage (RAA23012x)    |              | VBB_IN           | -0.3 to +6.5       | V                  | VBB_IN                                      |
| VIN input current(peak)               |              | IVIN(peak)-      | 4.2                | A                  | VIN                                         |
| LX output current(peak)               |              | ILX(peak)+       | 4.2                | A                  | LX                                          |
| VOUT sink current (DC)                |              | IVOUT(DC)-       | 100                | mA                 | VOUT<br>When discharge circuit<br>operation |
| GND voltage                           |              | GND              | -0.3 to +0.3       | V                  | GND                                         |
| Total power dissipation               | 16pin HTSSOP | PT               | 2900 <sup>*1</sup> | mW                 | $T_A \leq +25^{\circ}\text{C}$              |
|                                       | 8pin HLSOP   | PT               | 2600 <sup>*2</sup> |                    |                                             |
| Operating ambient temperature         |              | $T_A$            | -40 to +85         | $^{\circ}\text{C}$ |                                             |
| Operating junction temperature        |              | $T_J$            | -40 to +125        | $^{\circ}\text{C}$ |                                             |
| Storage temperature                   |              | $T_{\text{stg}}$ | -55 to +150        | $^{\circ}\text{C}$ |                                             |

Note: \*1 This is the value at  $T_A < +25^{\circ}\text{C}$ . At  $T_A > +25^{\circ}\text{C}$ , the total power dissipation decrease with  $-29.0 \text{ mW}/^{\circ}\text{C}$ .

Board specification : 4-layers glass epoxy board, 76.2mm x 114.3mm x 1.664mm.

Copper coverage area: 50%, 0.070mm thickness (top and bottom layers)

95%, 0.035mm thickness ( layers 2 and 3).

Connecting exposed pad

\*2 This is the value at  $T_A < +25^{\circ}\text{C}$ . At  $T_A > +25^{\circ}\text{C}$ , the total power dissipation decrease with  $-26.0 \text{ mW}/^{\circ}\text{C}$ .

Board specification : 4-layers glass epoxy board, 76.2mm x 114.3mm x 1.664mm.

Copper coverage area: 50%, 0.070mm thickness (top and bottom layers)

95%, 0.035mm thickness ( layers 2 and 3).

Connecting exposed pad

Caution: Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter.

That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

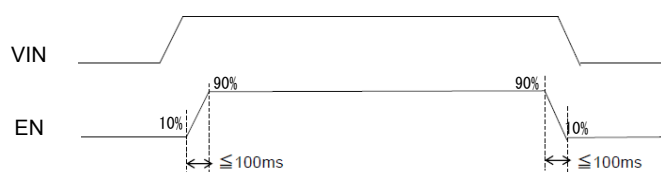
## Recommended Operating Condition

(Unless otherwise specified, TA = 25°C)

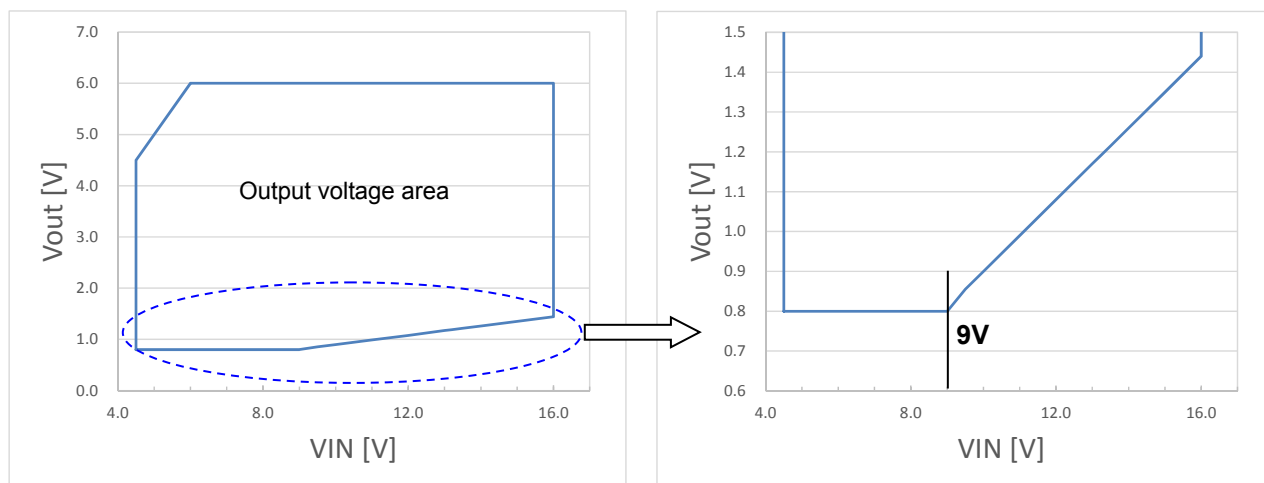
| Parameter                 | Symbol    | MIN. | TYP. | MAX. | Unit | Condition                       |
|---------------------------|-----------|------|------|------|------|---------------------------------|
| VIN applied voltage       | VIN       | 4.5  |      | 16.0 | V    | VIN                             |
| EN applied voltage        | EN        | 0    |      | 16.0 | V    | EN*1                            |
| x_AutoPFM applied voltage | x_AutoPFM | 0    |      | 16.0 | V    | x_AutoPFM                       |
| FB applied voltage        | FB        | 0    |      | 6.0  | V    | FB                              |
| VOOUT setting range       | Vdcdc_ext | *2   |      | 6.0  | V    | VOOUT set by external resistors |

\*1 About rising time (tr) and falling time (tf) of input signal to EN pin, when EN pin are not connected to power supply pin (VIN), set tr and tf less than 100ms.

When EN pin are connected to VIN pin, there are no restriction.



\*2 Output voltage (minimum value)



## Electrical Characteristics

(Unless otherwise specified, TA = 25°C, VIN = 12V)

| Parameter                             |                                          | Symbol    | MIN.  | TYP.  | MAX.    | Unit | Condition                                         |
|---------------------------------------|------------------------------------------|-----------|-------|-------|---------|------|---------------------------------------------------|
| Total                                 | Shutdown current                         | IDD(SHDN) |       | 1     | 10      | uA   | EN=GND                                            |
| Under voltage lock out circuit (UVLO) | Operating start voltage                  | Vrls(vin) | 3.6   | 3.9   | 4.2     | V    | VIN rising are detected                           |
|                                       | Operating stop voltage                   | Vdet(vin) | 3.4   | 3.7   | 4.0     | V    | VIN falling are detected                          |
| Internal power supply (VREG)          | Internal power supply voltage            | VREG      | 4.7   | 5.0   | 5.3     | V    | Ireg = 0mA, VIN=6V to 16V                         |
| Output (PWM mode)                     | E/A feedback voltage                     | vref07    | 0.693 | 0.700 | 0.707   | V    | Include input offset at external resistor setting |
|                                       | Output voltage accuracy                  | Vacc      | -2.5  |       | +2.5    | %    | Fixed VOUT products                               |
|                                       | High side FET on-resistance              | Ronh      |       | 180   |         | mΩ   | Io=100mA                                          |
|                                       | Low side FET on-resistance               | Ronl      |       | 130   |         | mΩ   | Io=100mA                                          |
| Discharge circuit                     | On-resistance                            | Rondc     |       | 100   | 200     | Ω    | Io=15mA                                           |
| Soft start                            | Soft start time <sup>*1</sup>            | tss       | 1.2   | 2     | 3.5     | ms   |                                                   |
| Thermal shutdown circuit              | Detect temperature <sup>*2</sup>         |           |       | 165   |         | °C   |                                                   |
|                                       | Hysteresis temperature <sup>*2</sup>     |           |       | 20    |         | °C   |                                                   |
| Logic input                           | High level threshold voltage             | VIH       | 1.3   |       | VIN+0.3 | V    | EN, x_AutoPFM                                     |
|                                       | Low level threshold voltage              | VIL       | -0.3  |       | 0.4     | V    | EN, x_AutoPFM                                     |
|                                       | Input current                            | IEN       |       | 1     |         | uA   | EN = 3.3V<br>x_AutoPFM = 3.3V                     |
| Battery backup (only RAA23012x)       | VBB input voltage range                  | VBB       | 2.7   | 3.0   | 3.7     | V    |                                                   |
|                                       | On-resistance between VBB_IN and VBB_OUT | Ron_vbat  |       | 400   |         | Ω    | VBB_OUT = VBB_IN, Io=0.5mA                        |
|                                       | On-resistance between VOUT and VBB_OUT   | Ron_vout  |       | 100   |         | Ω    | VBB_OUT = VOUT, Io=0.5mA                          |
|                                       | VBB leak current <sup>*1</sup>           | IL_BB     |       | 0.5   |         | uA   | VBB_OUT = VBB_IN = 3.0V, No load                  |

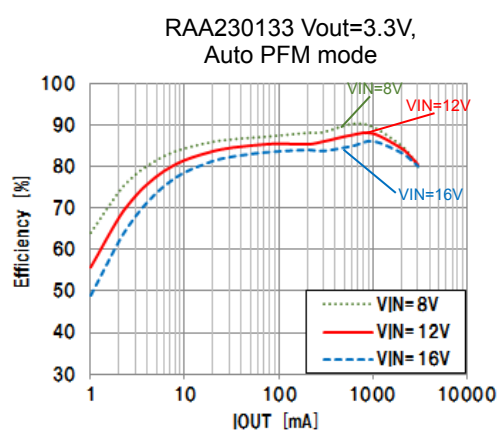
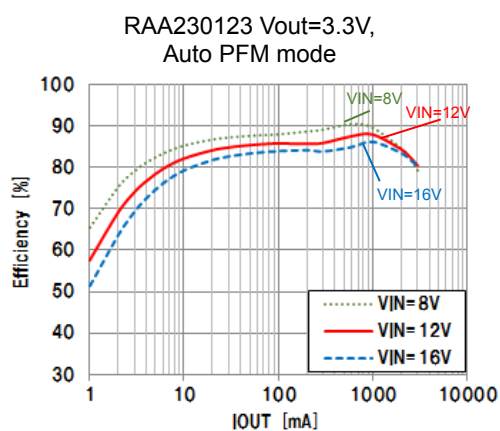
Note: <sup>\*1</sup> Reference value

<sup>\*2</sup> Not production tested.

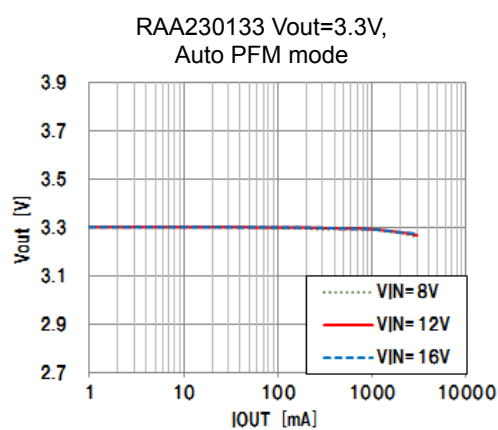
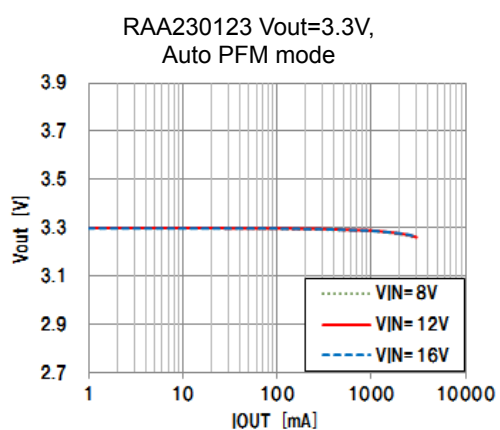
## Typical Performance Characteristics

(Unless otherwise specified,  $T_A = 25^\circ\text{C}$ )

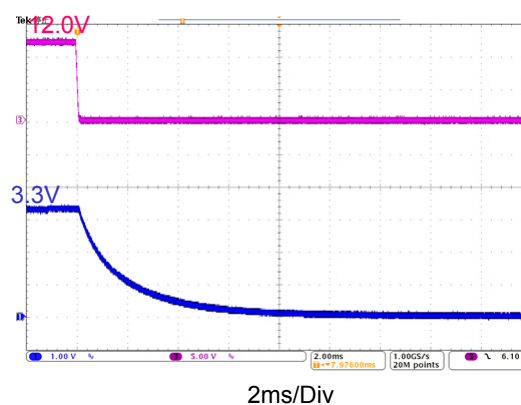
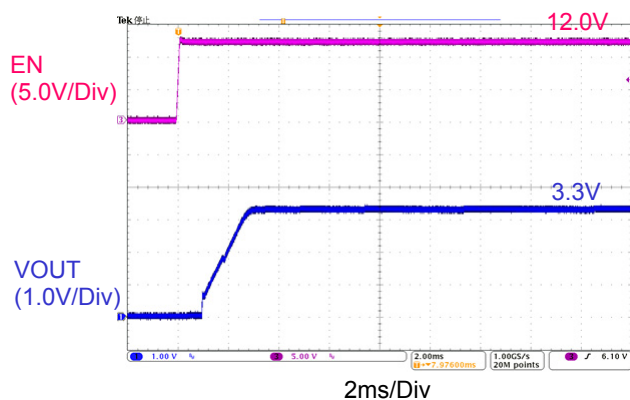
### Efficiency vs. Output Current



### Output voltage vs. Output Current

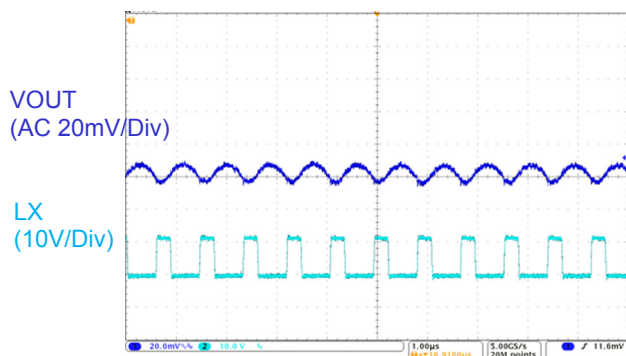


### Start-up and Shutdown Waveforms

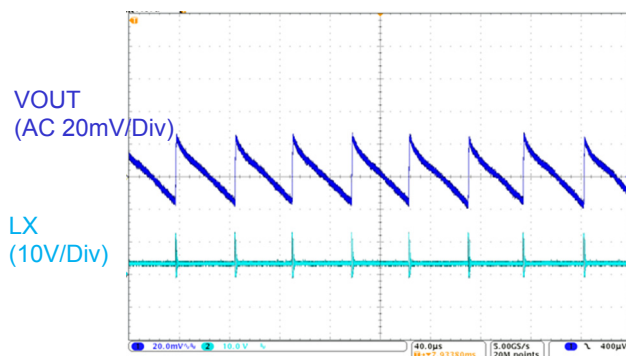


## Operation Waveforms

RAA230123, VIN=12V, Vout=3.3V, Iout=3.0A  
PWM mode

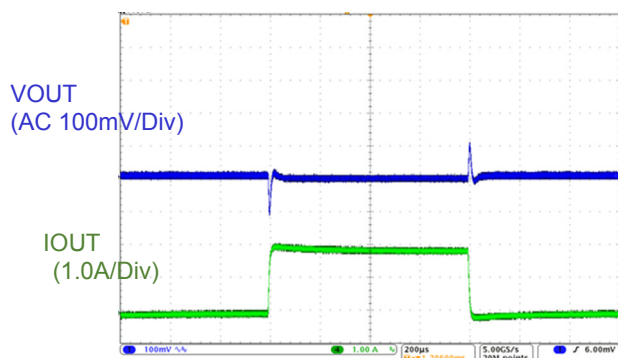


RAA230123, VIN=12V, Vout=3.3V, Iout=0.01A  
Auto PFM mode

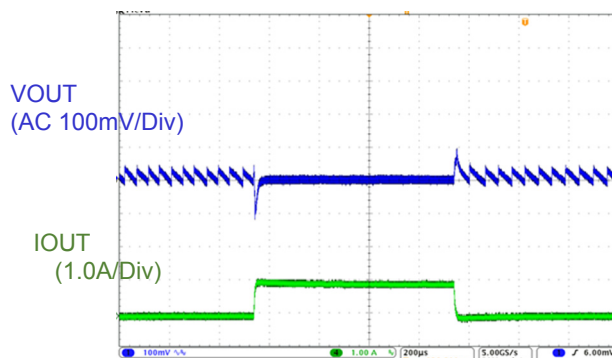


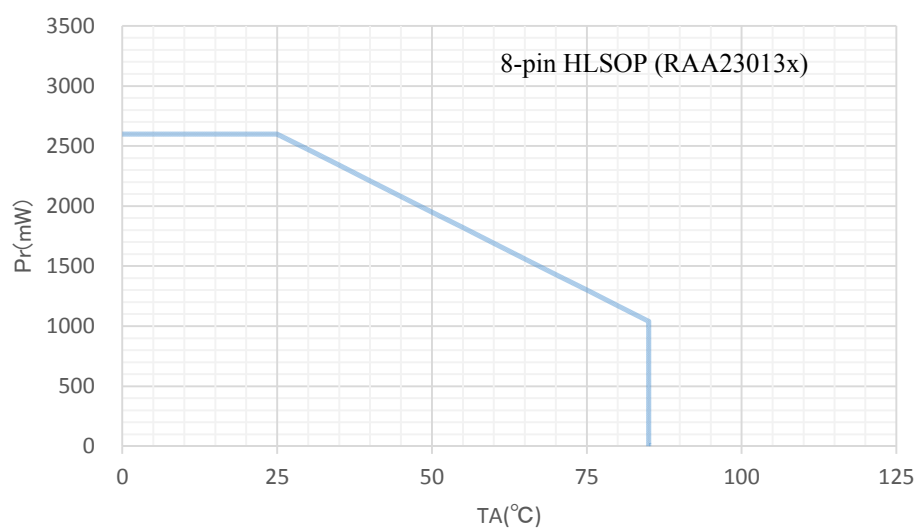
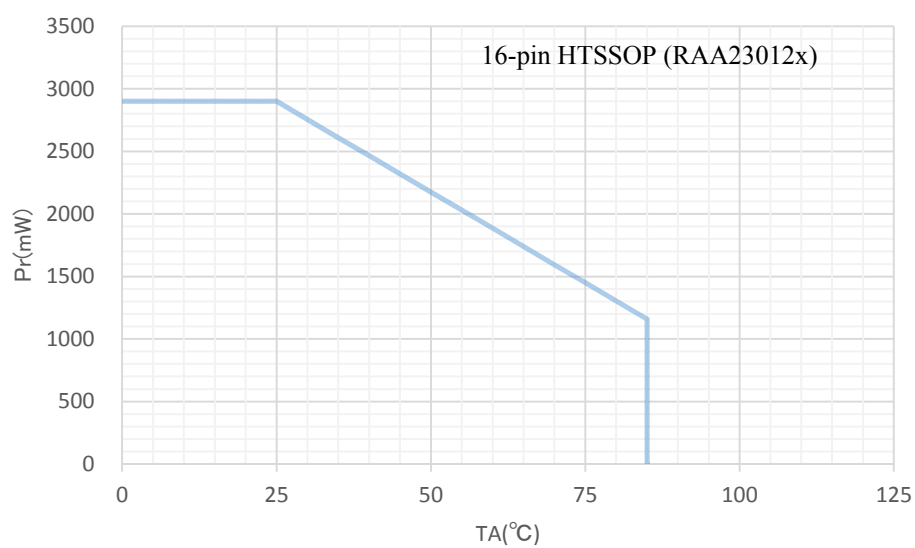
## Load Step Transient Waveforms

RAA230123, VIN=12V, Vout=3.3V, Iout=0.01A-2.0A  
PWM mode



RAA230123, VIN=12V, Vout=3.3V, Iout=0.01A-1.0A  
Auto PFM mode



**Temperature Derating Curve**

## Detailed Description

### Control Block

EN : ON/OFF setting

| EN | state     | VREG |
|----|-----------|------|
| L  | Shutdown  | 0V   |
| H  | Operation | 5.0V |

Note: L: Low level, H: High level

Note: There is no pull-down resistor within EN pin because of reducing power consumption at light load. Fix EN pin to high level or low.

x\_autoPFM : AutoPFM mode/ PWM mode setting (only RAA23012x)

| x_autoPFM | Operation                                                                                |
|-----------|------------------------------------------------------------------------------------------|
| L         | Auto PFM mode (change automatically)<br>PFM mode at light load<br>PWM mode at heavy load |
| H         | PWM mode (fixed)                                                                         |

Note: L: Low level, H: High level

Note: There is no pull-down resistor within x\_autoPFM pin because of reducing power consumption at light load.  
Fix x\_autoPFM pin to high level or low.

### Auto PFM mode

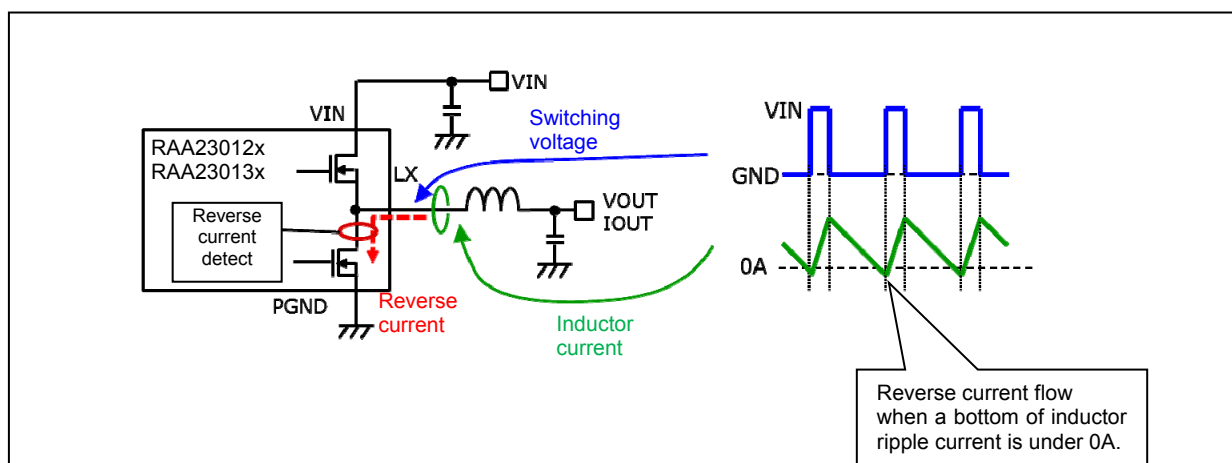
RAA23012x and RAA23013x have Auto PFM mode to achieve high efficiency over a wide load current range. The devices operate with PFM (Pulse Frequency Modulation) mode at light load current, and PWM (Pulse Width Modulation) mode at heavy load current. An operation mode is automatically switched depending on load current.

When a bottom of inductor ripple current is under 0A, reverse current flow at low-side N-channel MOSFET of output block. The devices operate with PFM mode during detecting this current. A current of switching PFM / PWM mode ( $I_{change}$ ) is calculated by an equation below.

$$I_{change} = \frac{\Delta IL}{2}$$

$$\Delta IL = \frac{(V_{IN} - V_{OUT})}{L} \times \frac{V_{OUT}}{V_{IN}} \times \frac{1}{f_{sw}}$$

L : inductance, fsw : 1.1MHz



RAA23012x has x\_autoPFM pin. When Low level, the devices operate Auto PFM mode (PFM mode / PWM mode changed automatically). When High level, the devices operate PWM mode, then not change into Auto PFM mode.

RAA23013x operates only Auto PFM mode.

**Soft Start**

To limit the startup inrush current and output voltage overshoot, a soft start circuit is used to ramp up the reference voltage from 0 V to its final value linearly. When EN pin is set from low level to high level, the device starts operation and output voltage rises with soft start. Soft start time are fixed at 2ms(Typ.) and no additional components are needed. Soft start feature gradually increases the error amplifier (E/A) input threshold voltage by using the voltage that is generated by the digital soft start (DSS) circuit.

## Discharge Circuit

The device has discharge circuit. This enables a rapid discharge without an external MOSFET. When an EN pin is changed from high level to low, discharge switch in VOUT pin is turned on and all capacitors which are connected to DC/DC output are rapidly discharged through VOUT pin. When VIN pin voltage becomes low level, discharge switch become off because there are no voltage to keep them on. The control voltage of discharge switches is VREG, and the discharge time of VREG capacitor is over 100ms when VIN voltage falls down, so even if EN pin is connected to VIN pin, output voltage can be discharged because VREG voltage level can keep the discharge switches on. When VREG voltage falls, VOUT pin becomes high impedance.

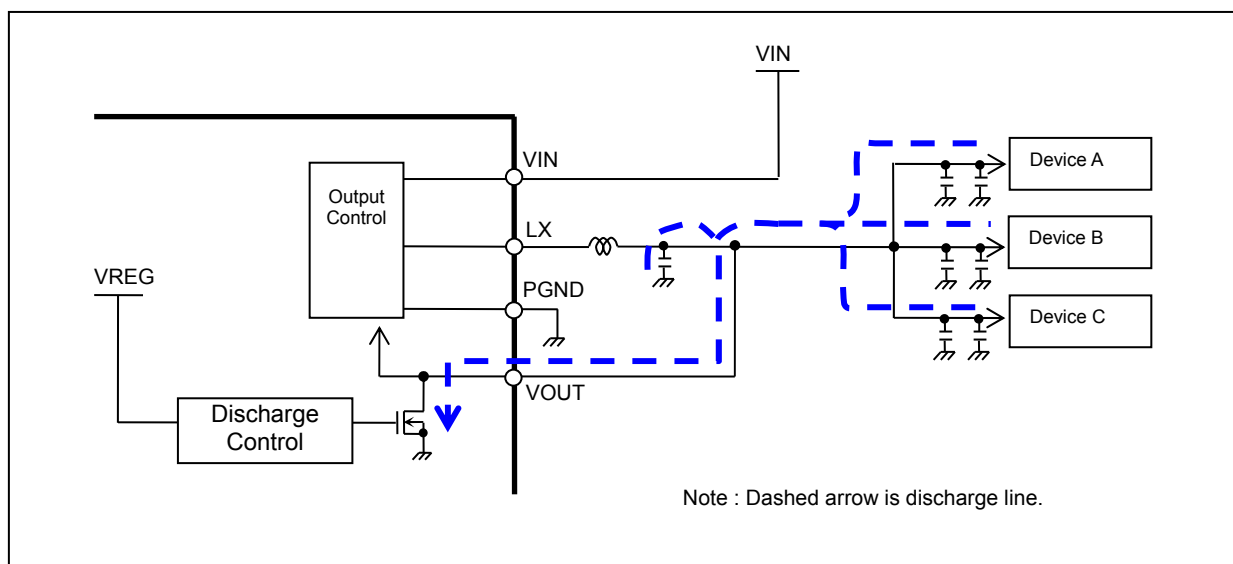
Discharge time can be calculated by an equation below.

$$V_{dc} = V_{OUT} \times e^{-\frac{t_{dc}}{C_{ALL} \times R_{ondc}}}$$

$V_{dc}$  is a voltage after  $t_{dc}(s)$ .

$C_{ALL}$  is sum of all capacitance which are connected to output (output capacitor, bypass capacitor around MCU, etc.).

$R_{ondc}$  is on resistance of discharge circuit.



**Battery Backup (RAA23012x)**

RAA23012x has a battery backup circuit which is used to operate some devices at system power-off. The circuit can be easily designed by RAA23012x without two diodes.

When DC/DC operates,  $V_{BB\_OUT} = V_{OUT}$ . When DC/DC stops and  $V_{OUT}$  pin voltage is higher than  $V_{BB\_IN}$  pin,  $V_{BB\_OUT} = V_{OUT}$  pin. When DC/DC stops and  $V_{OUT}$  pin voltage is lower than  $V_{BB\_IN}$  pin,  $V_{BB\_OUT} = V_{BB\_IN}$  pin.

$V_{BB\_OUT}$  voltage value is dependent on on-resistance between  $V_{BB\_IN}$  and  $V_{BB\_OUT}$ , On-resistance between  $V_{OUT}$  and  $V_{BB\_OUT}$  and  $V_{BB\_OUT}$  output current.  $V_{BB\_OUT}$  can be calculated by equations below.

1. Normal operation mode ( $V_{BB\_OUT} = V_{OUT}$ )

$$V_{BB\_OUT} = V_{OUT} - I_{BB\_OUT} \times R_{on\_vout}$$

2. Battery backup mode ( $V_{BB\_OUT} = V_{BB\_IN}$ )

$$V_{BB\_OUT} = V_{BB\_IN} - I_{BB\_OUT} \times R_{on\_vbat}$$

$V_{BB\_OUT}$  :  $V_{BB\_OUT}$  voltage (V)

$V_{OUT}$  :  $V_{OUT}$  voltage = DC/DC output voltage (V)

$V_{BB\_IN}$  :  $V_{BB\_IN}$  voltage = Battery voltage (V)

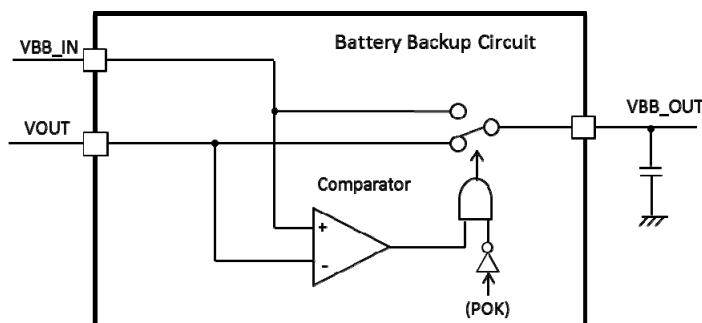
$I_{BB\_OUT}$  :  $V_{BB\_OUT}$  output current (A)

$R_{on\_vout}$  : On resistance between  $V_{OUT}$  and  $V_{BB\_OUT}$  100Ω (Typ.)

$R_{on\_vbat}$  : On resistance between  $V_{BB\_IN}$  and  $V_{BB\_OUT}$  400Ω (Typ.)

Note :  $2.7 \leq V_{BB\_OUT} \leq 3.7V$

Connect over 0.47μF capacitor to  $V_{BB\_OUT}$  pin.



Note :  $POK$  is an IC internal signal which identifies DC/DC operating status. It cannot be seen from IC outside.

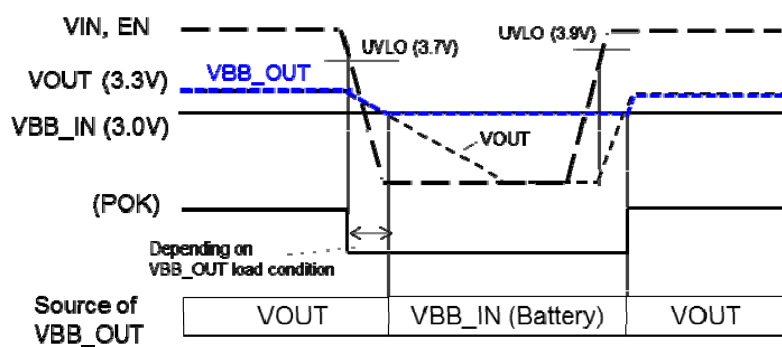
 **$V_{BB\_OUT}$  pin output status**

| DC/DC                      | $V_{OUT}$ , $V_{BB\_IN}$                                  | $V_{BB\_OUT}$ |
|----------------------------|-----------------------------------------------------------|---------------|
| Operation<br>( $POK = H$ ) | $V_{OUT} \geq V_{BB\_IN}$<br>or<br>$V_{OUT} < V_{BB\_IN}$ | $V_{OUT}$     |
| Stop<br>( $POK = L$ )      | $V_{OUT} \geq V_{BB\_IN}$                                 | $V_{OUT}$     |
|                            | $V_{OUT} < V_{BB\_IN}$                                    | $V_{BB\_IN}$  |

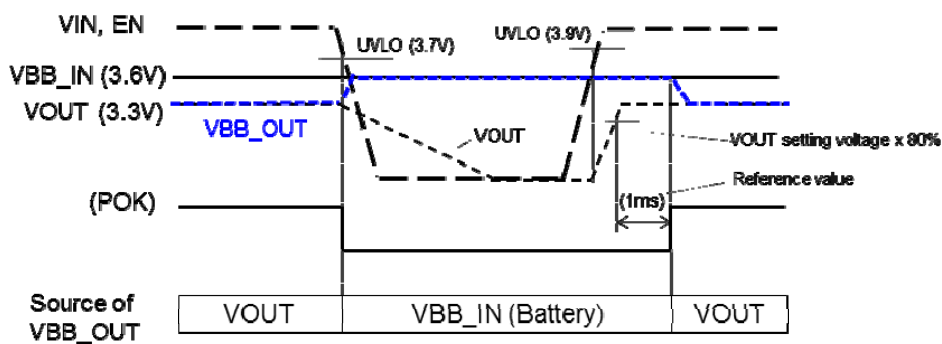
Note : L: Low level, H: High level

## Timing chart of battery backup

## 1. With 3.0V battery



## 2. With 3.6V battery



**Protection Circuit View**

| Protection circuit                   | Function                                                                    | Operation status            |                | Reset                                                                                                       |
|--------------------------------------|-----------------------------------------------------------------------------|-----------------------------|----------------|-------------------------------------------------------------------------------------------------------------|
|                                      |                                                                             | Common circuit (VREG, etc.) | Output         |                                                                                                             |
| Short circuit protection (SCP)       | Detect output voltage dropping because of short circuit, etc. (Latch type)  | Operation                   | Latched to off | Turn EN pin from high level to low level<br>or<br>Drop VIN pin voltage under operation stop voltage of UVLO |
| Thermal shutdown circuit (TSD)       | Detect rise up of IC internal temperature (Over 165°C) (Auto recovery type) | Operation                   | Stop           | The temperature falls                                                                                       |
| Under voltage lockout circuit (UVLO) | Detect dropping of VIN (Auto recovery type)                                 | Operation                   | Stop           | Up VIN over operating start voltage (3.9V)                                                                  |

Note SCP : Short Circuit Protection  
TSD : Thermal Shutdown Circuit  
UVLO : Under Voltage Lockout Circuit

**Short Circuit Protection (Latch type)**

When output voltage drops, FB pin input voltage also drops. If this voltage falls below the input detection voltage of the short circuit protection, the output are stopped (latched to OFF). At this time, common circuits (such as the internal power supply block, etc.) continue operating.

When the protection is operating, to reset the latch, either turn the EN pin from high to low or drop the VIN pin voltage under operation stop voltage of UVLO.

**Thermal Shutdown Circuit (Auto Recovery Type)**

When overheating has been detected (detect temperature: 165°C), the output is stopped. Then, power MOSFET of output both high side and low side are turned off. Common circuits (such as the internal power supply block, etc.) continue operating.

If the device temperature falls and becomes under detect temperature, the protection is canceled and output automatically resumes.

**Under Voltage Lockout Circuit (Auto Recovery Type)****(1) Under voltage lockout operation**

When the power supply voltage (VIN) falls to the operation stop voltage (3.7V), output from all channels stops. Common circuits (such as the internal power supply block, etc.) continue operating.

**(2) Restoring output**

Once VIN is restored to the Operating start voltage (3.9V), the under voltage lockout operation is canceled and output automatically resumes. The output voltage cannot be restored while the under voltage lockout circuit is operating, not even by manipulating the EN pin.

**Current Limiting**

If an overcurrent occurs, an output current is limited on a pulse-by-pulse basis. If the current sensor detects an overcurrent, the current is limited and the switching operation of the Power MOSFET in the output stage stops until the next cycle.

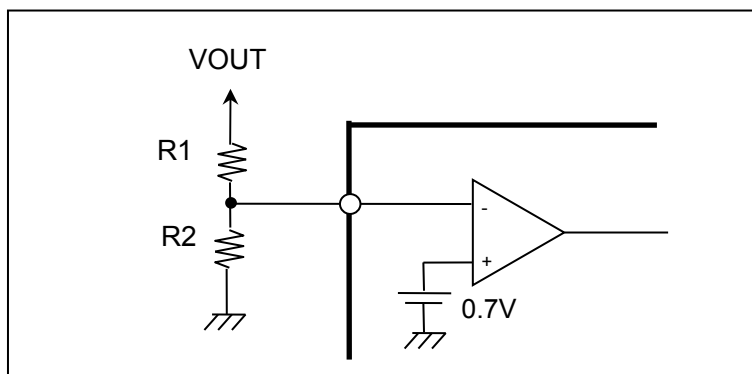
When an output current is limited, the output voltage drops. If a FB pin voltage falls below the input detection voltage, the short-circuit protection circuit starts operating.

## Guide for Circuit Design

### Setting Output Voltage (When the output voltage is set by external resistor)

The output voltage can be calculated by an equation below.

$$V_{OUT} = 0.7 \times (1 + R1 / R2)$$



#### Examples of R1 and R2 selection

| Vout | 0.9V | 1.0V | 1.05V | 1.1V | 1.18V | 1.2V | 1.5V | 1.8V | 2.5V | 3.3V | 5.0V |
|------|------|------|-------|------|-------|------|------|------|------|------|------|
| R1   | 110k | 100k | 100k  | 91k  | 110k  | 130k | 150k | 130k | 100k | 100k | 110k |
| R2   | 390k | 240k | 200k  | 160k | 160k  | 180k | 130k | 82k  | 39k  | 27k  | 18k  |

### Output voltage accuracy (When the output voltage is set by external resistor)

Output voltage accuracy can be calculated by an equation below.

$$V_{OUTACC} = V_{ITHACC} + \frac{(V_{out} - V_{ITH})}{V_{out}} \times 2 \times R_{ACC}$$

$V_{OUTACC}$  is the output voltage accuracy (%).

$V_{ITHACC}$  is the E/A input threshold voltage accuracy (%).

$V_{OUT}$  is the output voltage (V).

$R_{ACC}$  is the external resistor accuracy (%).

So, an output voltage accuracy of the device is below.

$$V_{OUTACC} = 1 + \frac{(V_{out} - 0.7)}{V_{out}} \times 2 \times R_{ACC}$$

Note : These equation don't include Vout fluctuation by load step transient.

## Inductor selection

An inductor target is that ripple current ( $\Delta IL$ ) of inductor becomes 10 to 40 % of  $I_{out(max)}$ .

When  $\Delta IL$  increases, inductor current peak raises, so ripple of  $V_{out}$  gets larger and power loss increases. But, large size inductor is required to lower  $\Delta IL$ .

$\Delta IL$  can be calculated by an equation below.

$$\Delta IL = \frac{(V_{in} - V_{out})}{L} \times \frac{V_{out}}{V_{in}} \times \frac{1}{f_{sw}}$$

$f_{sw}$  is 1.1MHz.

Peak current of inductor ( $IL_{peak}$ ) can be calculated by an equation below.

$$IL_{peak} = I_{OUT(MAX)} + \frac{\Delta IL}{2}$$

Choose a inductor which saturation current is higher than  $IL_{peak}$ .

## Inductor Example

| Inductance (uH) | Inductor        | Manufacturer | $I_{TEMP}$ (A) | $I_{SAT}$ (A) | Size (LxWxT, mm) |
|-----------------|-----------------|--------------|----------------|---------------|------------------|
| 2.2             | NRS5024T2R2NMGJ | TAIYO YUDEN  | 3.1            | 4.1           | 4.9x4.9x2.4      |
| 2.2             | 744778002       | WURTH        | 4.0            | 4.8           | 7.3x7.3x3.2      |
| 3.3             | NRS5030T3R3MMGJ | TAIYO YUDEN  | 3.0            | 3.6           | 4.9x4.9x3.1      |
| 3.3             | 7447789003      | WURTH        | 3.4            | 4.2           | 7.3x7.3x3.2      |
| 4.7             | NRS5040T4R7NMGK | TAIYO YUDEN  | 3.1            | 3.3           | 4.9x4.9x4.1      |
| 4.7             | 744777004       | WURTH        | 4.0            | 4.0           | 7.3x7.3x4.3      |

Note  $I_{TEMP}$  : Rated current by temperature rising

$I_{SAT}$  : Rated current by inductance loss

These inductors are examples. About inductor detail, contact each manufacturer

**Output capacitor selection**

RAA23012x and RAA23013x have a phase compensation circuit which is optimized to DC/DC operation. In order to operate stably with the phase compensation, connect the output capacitor which is over 22 uF. Ceramic capacitor can be used for output capacitor. It has low ESR, so VOUT ripple is decreased.

VOUT ripple ( $\Delta V_{rpl}$ ) can be calculated by an equation below.

$$\Delta V_{rpl} = \Delta I L \times \left( ESR + \frac{1}{(8 \times C_{OUT} \times f_{SW})} \right)$$

ESR : Equivalent Series Resistance

**Input capacitor selection**

Connect an input capacitor which is over 10 uF between each VIN pin and power ground. It should be placed close to the device as possible.

**VREG capacitor**

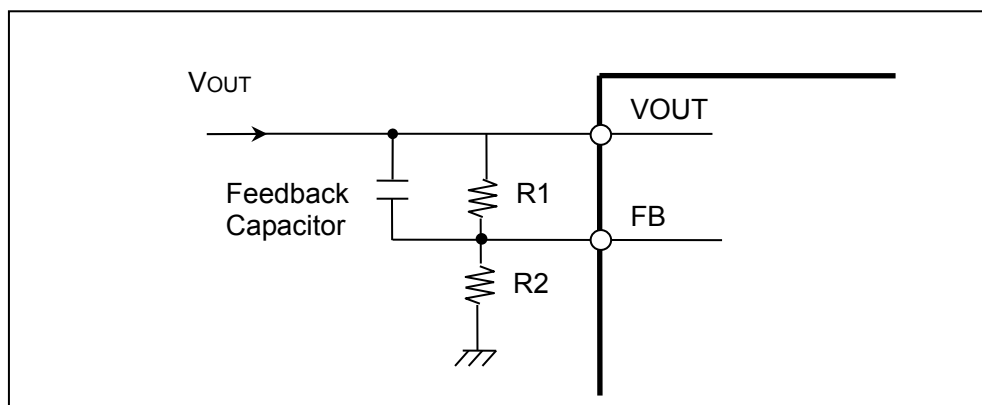
Connect 1uF ceramic capacitor to VREG pin.

**Bootstrap capacitor**

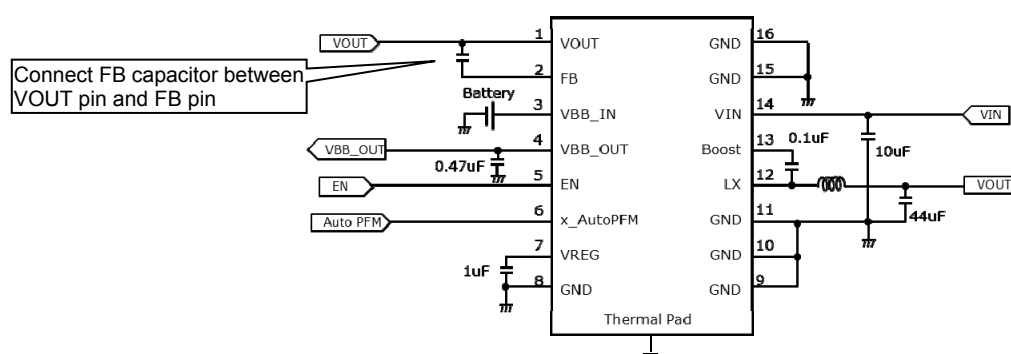
Connect 0.1uF ceramic capacitor between LX pin and Boost pin.

## Feedback capacitor

When PFM operation at Auto PFM mode, feedback capacitor can be connected in parallel to high side output voltage setting resistor to adjust phase characteristic. If connected, there are possibility that operation in large current (at PWM operation) is not stable. Confirm the operation with system status.

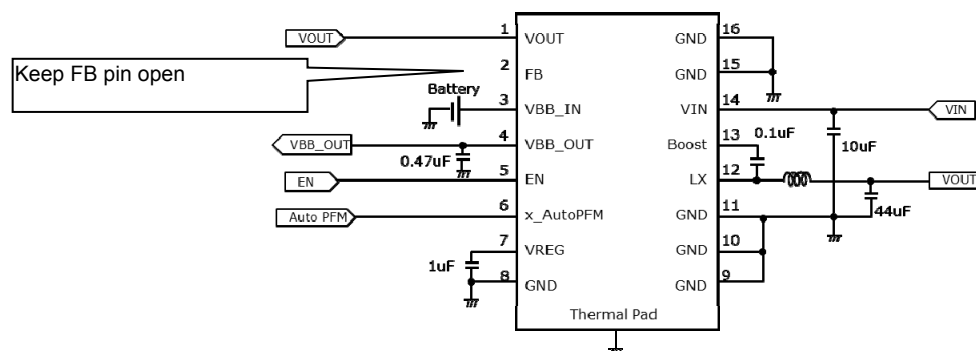


When using feedback capacitor with an output voltage fixed product, connect feedback capacitor between VOUT pin and FB pin.



Example of RAA230121, RAA230122

When not using feedback capacitor with an output voltage fixed product, keep FB pin open.



Example of RAA230121, RAA230122

**Components example**

| VIN (V) | VOUT (V) | L (uH) | Cout (uF) | C <sub>FB</sub> (pF) |          |
|---------|----------|--------|-----------|----------------------|----------|
|         |          |        |           | Auto PFM mode        | PWM mode |
| 12      | 5V       | 3.3    | 22 to 44  | 0 to 100             | No need  |
|         | 3.3V     | 3.3    | 22 to 44  | 0 to 100             | No need  |
|         | 1.2V     | 3.3    | 22 to 44  | 0 to 100             | No need  |
| 5       | 3.3      | 2.2    | 22        | 0 to 100             | No need  |
|         | 1.2      | 2.2    | 22        | 0 to 100             | No need  |

## Notes on Use

### Pattern Wiring

To actually perform pattern wiring, separate a ground of control signal from a ground of a power line, so that these grounds do not have a common impedance as much as possible.

### Connection of Exposed PAD

HTSSOP and HLSOP packages have an Exposed PAD on the bottom to improve radiation performance. On the mounting board, connect this Exposed PAD to GND.

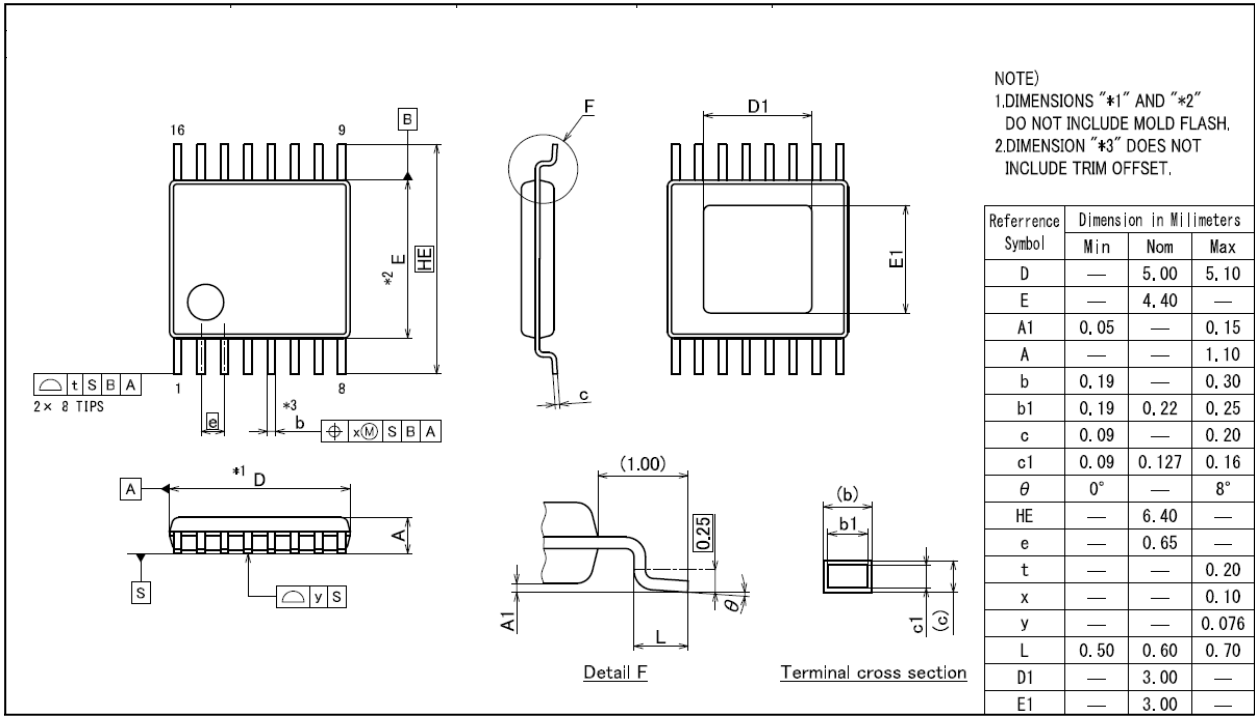
### Fixed Usage of Control Input Pin

When EN pin and x\_AutoPFM pin are fixed, connect to a pin listed below.

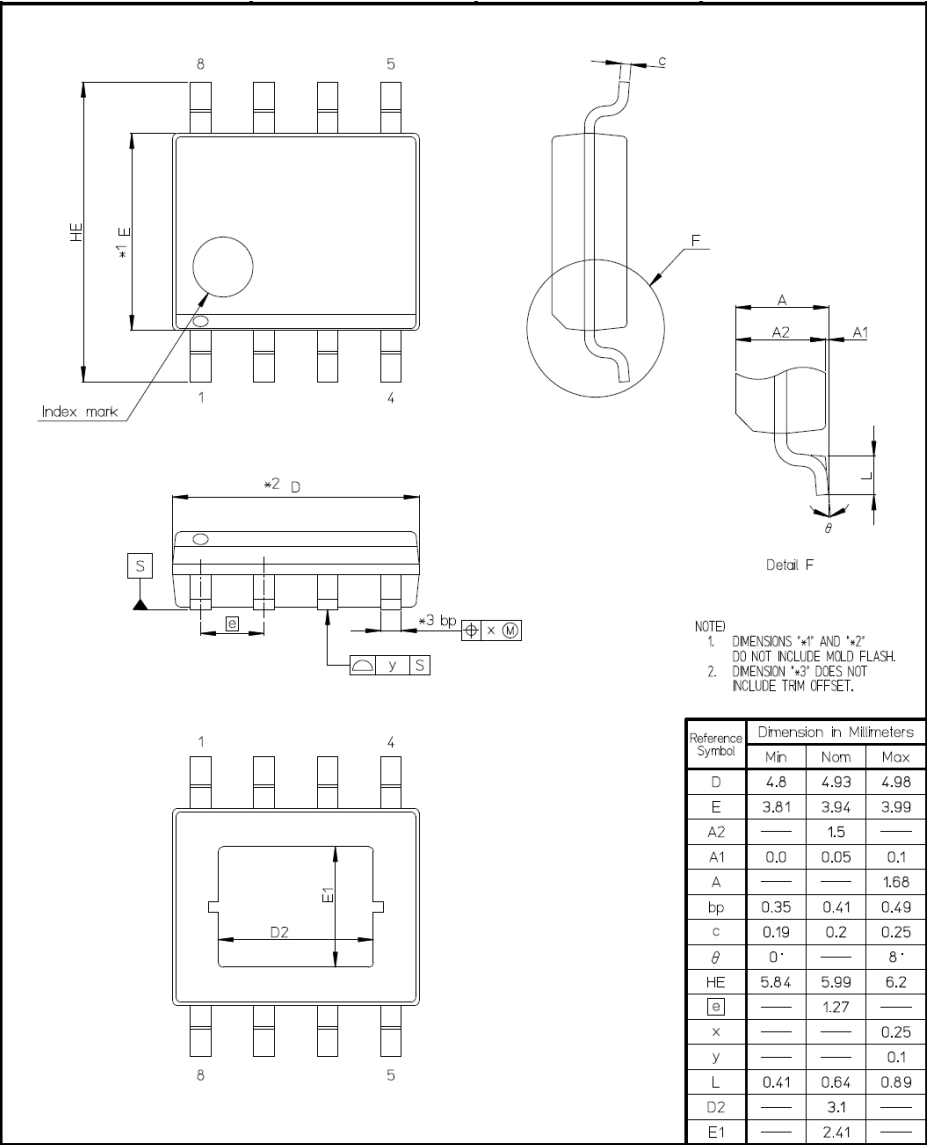
| Input Pin | Connect Pin        |                     |
|-----------|--------------------|---------------------|
|           | Fixed to Low Level | Fixed to High Level |
| EN        | GND                | VIN                 |
| x_AutoPFM | GND                | VIN                 |

Package Dimensions

16pin TSSOP (RAA23012x)  
Renesas code : PTSP0016JC-A



8pin HLSOP (RAA23013x)  
Renesas code : PLSP0008DB-A



|                         |                                        |
|-------------------------|----------------------------------------|
| <b>Revision History</b> | <b>RAA23012x, RAA23013x Data Sheet</b> |
|-------------------------|----------------------------------------|

| Rev. | Date        | Description |                       |
|------|-------------|-------------|-----------------------|
|      |             | Page        | Summary               |
| 1.00 | Apr.15.2015 | -           | First Edition issued. |
|      |             |             |                       |

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